

APT20M40JN 200V 77.0A 0.040Ω  
 APT20M45JN 200V 73.0A 0.045Ω

UL "UL Recognized" File No. E145592 (S)

**POWER MOS IV™**

**SINGLE DIE ISOTOP® PACKAGE**

**N - CHANNEL ENHANCEMENT MODE HIGH VOLTAGE POWER MOSFETS**

**MAXIMUM RATINGS**

All Ratings: T<sub>C</sub> = 25°C unless otherwise specified.

Symbol	Parameter	APT 20M40JN	APT 20M45JN	UNIT
V <sub>DSS</sub>	Drain-Source Voltage	200	200	Volts
I <sub>D</sub>	Continuous Drain Current @ T <sub>C</sub> = 25°C	77	73	Amps
I <sub>DM</sub> , I <sub>LM</sub>	Pulsed Drain Current ① and Inductive Current Clamped	308	292	
V <sub>GS</sub>	Gate-Source Voltage	±30		Volts
P <sub>D</sub>	Total Power Dissipation @ T <sub>C</sub> = 25°C	520		Watts
	Linear Derating Factor	4.16		W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to 150		°C
T <sub>L</sub>	Lead Temperature: 0.063" from Case for 10 Sec.	300		

**STATIC ELECTRICAL CHARACTERISTICS**

Symbol	Characteristic / Test Conditions / Part Number	MIN	TYP	MAX	UNIT
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage (V <sub>GS</sub> = 0V, I <sub>D</sub> = 250 μA)	APT20M40JN	200		Volts
		APT20M45JN	200		
I <sub>D(ON)</sub>	On State Drain Current ② (V <sub>DS</sub> > I <sub>D(ON)</sub> × R <sub>DS(ON)</sub> Max, V <sub>GS</sub> = 10V)	APT20M40JN	77		Amps
		APT20M45JN	73		
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance ② (V <sub>GS</sub> = 10V, 0.5 I <sub>D</sub> [Cont.])	APT20M40JN		0.040	Ohms
		APT20M45JN		0.045	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current (V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0V)			250	μA
	Zero Gate Voltage Drain Current (V <sub>DS</sub> = 0.8 V <sub>DSS</sub> , V <sub>GS</sub> = 0V, T <sub>C</sub> = 125°C)			1000	
I <sub>GSS</sub>	Gate-Source Leakage Current (V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V)			±100	nA
V <sub>GS(TH)</sub>	Gate Threshold Voltage (V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 2.5mA)	2		4	Volts

**THERMAL CHARACTERISTICS**

Symbol	Characteristic	MIN	TYP	MAX	UNIT
R <sub>θJC</sub>	Junction to Case			0.24	°C/W
R <sub>θCS</sub>	Case to Sink (Use High Efficiency Thermal Joint Compound and Planer Heat Sink Surface.)		0.06		

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

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DYNAMIC CHARACTERISTICS

APT20M40/20M45JN

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{ MHz}$		5830	6800	pF
$C_{oss}$	Output Capacitance			2270	3000	
$C_{riss}$	Reverse Transfer Capacitance			1030	1440	
$Q_g$	Total Gate Charge ③	$V_{GS} = 10V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = I_D [\text{Cont.}] @ 25^\circ\text{C}$		280	370	nC
$Q_{gs}$	Gate-Source Charge			39	60	
$Q_{gd}$	Gate-Drain ("Miller") Charge			162	220	
$t_d(\text{on})$	Turn-on Delay Time	$V_{GS} = 15V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = I_D [\text{Cont.}] @ 25^\circ\text{C}$ $R_G = 0.6\Omega$		17	34	ns
$t_r$	Rise Time			55	110	
$t_d(\text{off})$	Turn-off Delay Time			49	75	
$t_f$	Fall Time			16	32	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$I_S$	Continuous Source Current (Body Diode)	APT20M40JN		77	Amps
		APT20M45JN		73	
$I_{SM}$	Pulsed Source Current ① (Body Diode)	APT20M40JN		308	Amps
		APT20M45JN		292	
$V_{SD}$	Diode Forward Voltage ② ( $V_{GS} = 0V, I_S = -I_D [\text{Cont.}]$ )			1.8	Volts
$t_{rr}$	Reverse Recovery Time ( $I_S = -I_D [\text{Cont.}], di_S/dt = 100A/\mu s$ )	120	240	480	ns
$Q_{rr}$	Reverse Recovery Charge ( $I_S = -I_D [\text{Cont.}], di_S/dt = 100A/\mu s$ )	1.3	2.7	5.4	$\mu\text{C}$

PACKAGE CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$L_D$	Internal Drain Inductance (Measured From Drain Terminal to Center of Die.)		3		nH
$L_S$	Internal Source Inductance (Measured From Source Terminals to Source Bond Pads)		5		
$V_{Isolation}$	RMS Voltage (50-60 Hz Sinusoidal Waveform From Terminals to Mounting Base for 1 Min.)	2500			Volts
$C_{Isolation}$	Drain-to-Mounting Base Capacitance ( $f = 1\text{ MHz}$ )		35		pF
Torque	Maximum Torque for Device Mounting Screws and Electrical Terminations.			13	in-lbs

① Repetitive Rating: Pulse width limited by maximum junction temperature. See Transient Thermal Impedance Curve. (Fig.1)

② Pulse Test: Pulse width < 380  $\mu\text{s}$ , Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

APT Reserves the right to change, without notice, the specifications and information contained herein.

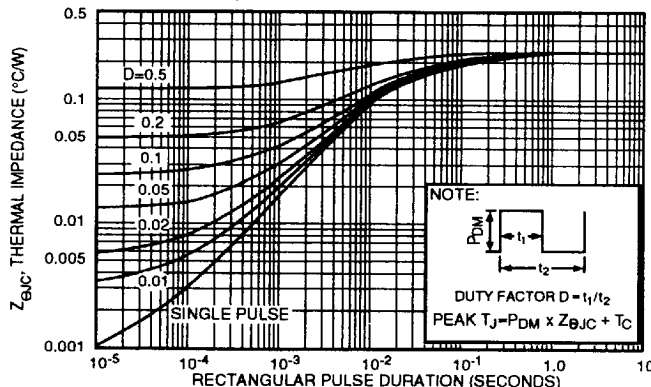


FIGURE 1. MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

APT20M40/20M45JN

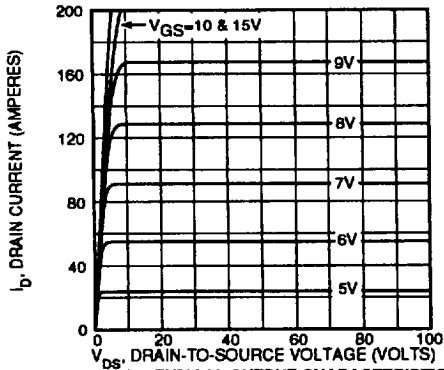


FIGURE 2, TYPICAL OUTPUT CHARACTERISTICS

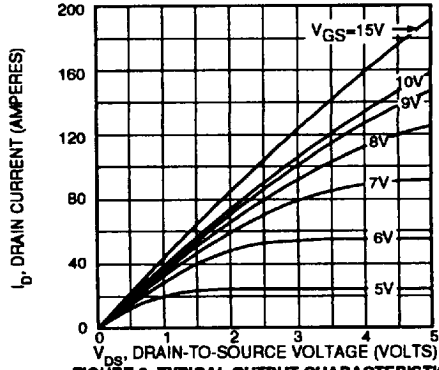


FIGURE 3, TYPICAL OUTPUT CHARACTERISTICS

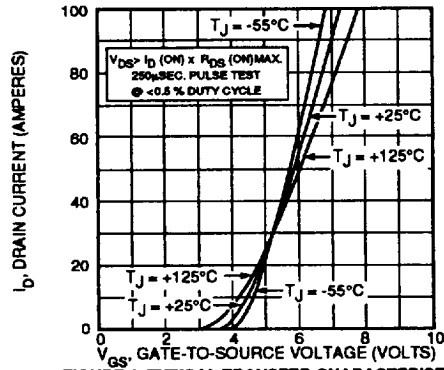


FIGURE 4, TYPICAL TRANSFER CHARACTERISTICS

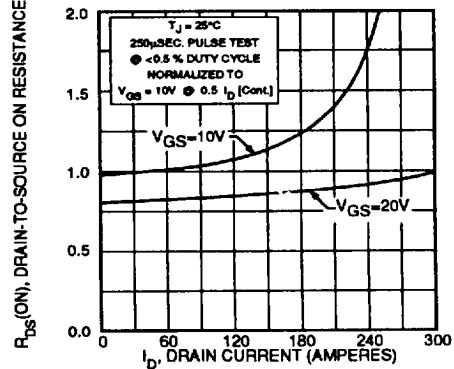


FIGURE 5,  $R_{DS(ON)}$  vs. DRAIN CURRENT

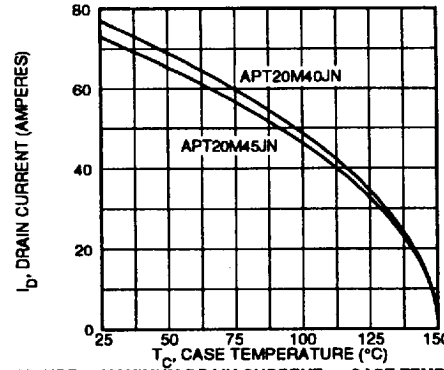


FIGURE 6, MAXIMUM DRAIN CURRENT vs. CASE TEMPERATURE

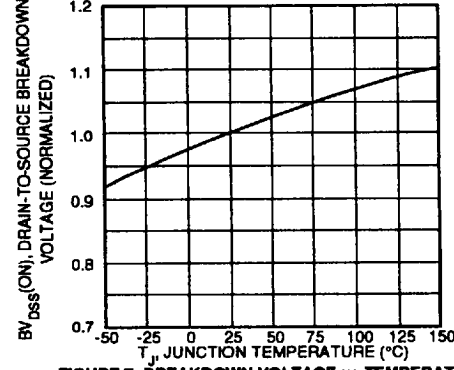


FIGURE 7, BREAKDOWN VOLTAGE vs. TEMPERATURE

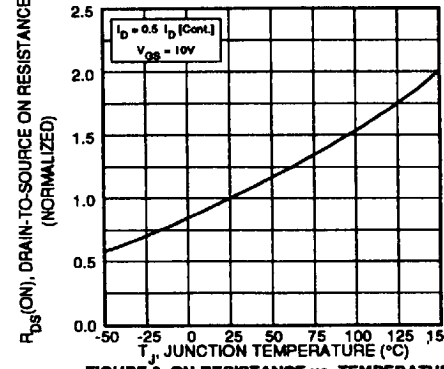


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

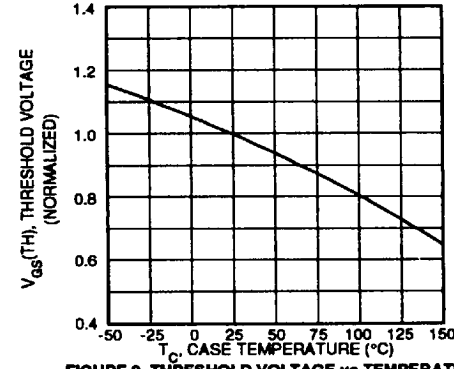


FIGURE 9, THRESHOLD VOLTAGE vs. TEMPERATURE

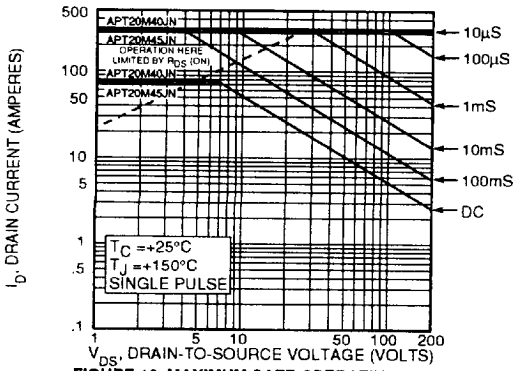


FIGURE 10, MAXIMUM SAFE OPERATING AREA

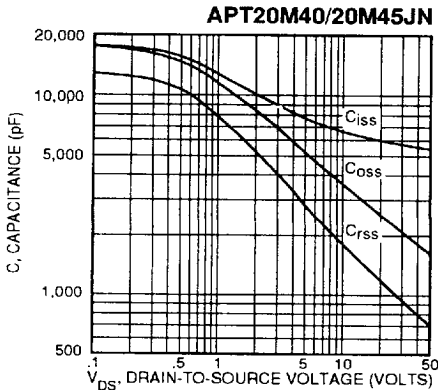


FIGURE 11, TYPICAL CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

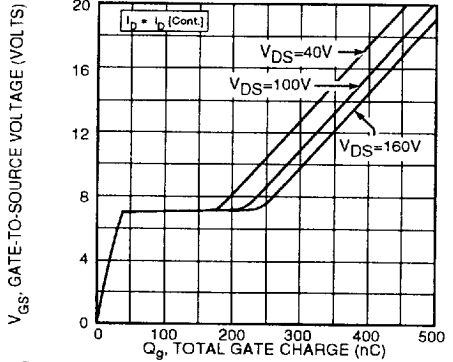


FIGURE 12, GATE CHARGES vs GATE-TO-SOURCE VOLTAGE

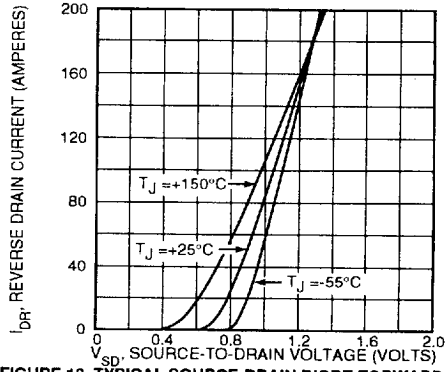
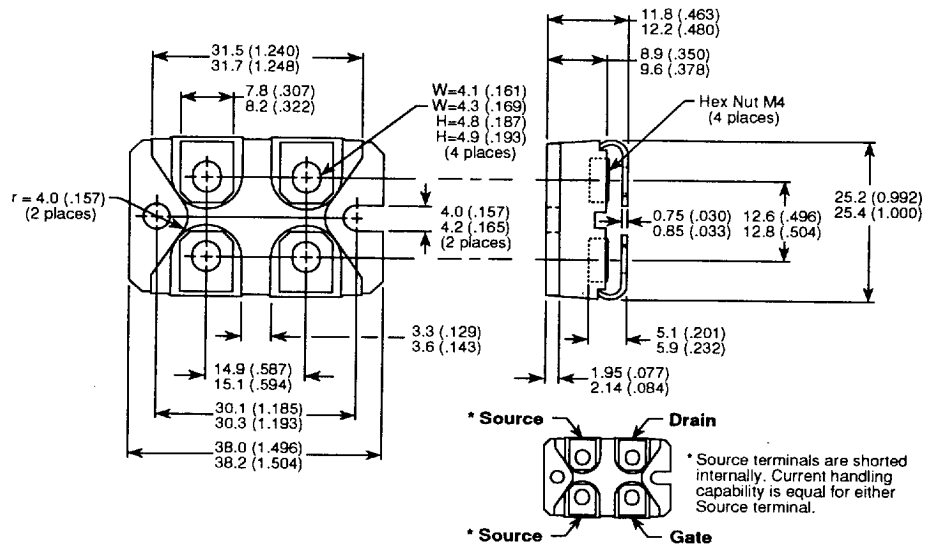


FIGURE 13, TYPICAL SOURCE-DRAIN DIODE FORWARD VOLTAGE

SOT-227 (ISOTOP<sup>®</sup>) Package Outline



Dimensions in Millimeters and (Inches)

ISOTOP<sup>®</sup> is a Registered Trademark of SGS Thomson.

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Rev B